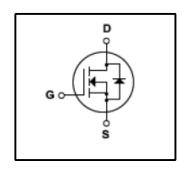


Silicon N-Channel MOSFET

Features

- 12A,650V,R_{DS}(on)(Max0.78Ω)@V_{GS}=10V
- Ultra-low Gate Charge(Typical 51.7nC)
- Fast Switching Capability
- 100%Avalanche Tested
- Maximum Junction Temperature Range(150°C)



General Description

This Power MOSFET is produced using Winsemi's advanced planar stripe, VDMOS technology. This latest technology has been especially designed to minimize on-state resistance, have a high rugged avalanche characteristics. This devices is specially well suited for AC-DCswitching power supplies, DC-DCpower converters, high voltage H-bridge motor drive PWM



Absolute Maximum Ratings

Symbol	Parameter		Value	Units
V _{DSS}	Drain Source Voltage		650	V
lo	Continuous Drain Current(@Tc=25°C)		12	Α
ID	Continuous Drain Current(@Tc=100℃)			А
Ідм	Drain Current Pulsed	(Note1)		Α
Vgs	Gate to Source Voltage		±30	V
Eas	Single Pulsed Avalanche Energy	(Note 2)	990	mJ
Ear	Repetitive Avalanche Energy	(Note 1)	22	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	4.5	V/ns
Pp	Total Power Dissipation(@Tc=25℃)		51	W
PD	Derating Factor above 25°C		0.41	W/°C
TJ, Tstg	Junction and Storage Temperature		-55~150	$^{\circ}$
T∟	Channel Temperature	·	300	$^{\circ}$

Thermal Characteristics

Cymphol	Darameter	Value			Linita	
Symbol	Parameter	Min	Тур	Max	Units	
Rajc	Thermal Resistance, Junction-to-Case	-	-	2.45	°C/W	
Rqcs	Thermal Resistance, Case-to-Sink	-	-	-	°C/W	
RQJA	Thermal Resistance, Junction-to-Ambient	-	-	62.5	°C/W	





Electrical Characteristics (Tc = 25° C)

Charac	teristics	Symbol	Test Condition	Min	Туре	Max	Unit
Gate leakage cu	rrent	Igss	V _G S = ±30 V, V _D S = 0 V	-	-	\pm 100	nA
Gate-source bre	akdown voltage	V(BR)GSS	I _G = ±10 μA, V _{DS} = 0 V	±30	-	-	V
Drain cut-off current		n cut-off current loss		-	-	10	μA
		IDSS	V _{DS} = 480 V, Tc = 125℃	-	-	100	μA
Drain-source bre	eakdown voltage	V(BR)DSS	ID = 250 μA, VGS = 0 V	650	-	-	V
Gate threshold v	oltage	VGS(th)	V _{DS} = 10 V, I _D =250 μA	3	-	4.5	V
Drain-source ON	N resistance	R _{DS(ON)}	V _{GS} = 10 V, I _D = 6A	-	0.64	0.78	Ω
Forward Transco	onductance	gfs	V _{DS} = 50 V, I _D = 6A	-	6.4	-	S
Input capacitance		Ciss	V _{DS} = 25 V,	-	1830	-	
Reverse transfer capacitance		Crss	V _G S = 0 V,	-	2.2	-	pF
Output capacitance		Coss	f = 1 MHz	-	155	-	
	Rise time	tr	V _{DD} =325 V,	-	50	-	ns
Cusitah ing tina	Turn-on time	ton	ID =12A	-	49	-	
Switching time	Fall time	tf	R _G =25 Ω	-	310	-	
	Turn-off time	toff	(Note4,5)	-	54	-	
Total gate charge (gate-source		0.5	V _{DD} = 520 V,		F4 7		
plus gate-drain)		Qg	V _G S = 10 V,	-	51.7	-	-0
Gate-source charge		Qgs	ID = 12 A	-	9.6	-	nC
Gate-drain ("miller") Charge		Qgd	(Note4,5)	-	18.6	-	

Source-Drain Ratings and Characteristics (Ta = 25° C)

Characteristics	Symbol	Test Condition	Min	Туре	Max	Un it
Continuous drain reverse current	IDR	-	-	-	12	Α
Pulse drain reverse current	IDRP	-	-	-	48	Α
Forward voltage (diode)	VDSF	IDR = 12 A, VGS = 0 V	-	-	1.4	V
Reverse recovery time	trr	IDR = 12 A, VGS = 0 V,	-	450	-	ns
Reverse recovery charge	Qrr	dl _{DR} / dt = 100 A / μs	-	5.0	-	μC

Note 1.Repeativity rating :pulse width limited by junction temperature

2.L=14mH,Ias=12A,VDD=95V,Rg=25 Ω ,Starting TJ=25 $^{\circ}$ C

3.Isp≤12A,di/dt≤200A/us, Vpp<BVpss,STARTING TJ=25 $^{\circ}\mathrm{C}$

4.Pulse Test: Pulse Width≤300us,Duty Cycle≤2%

5. Essentially independent of operating temperature.

This transistor is an electrostatic sensitive device

Please handle with caution



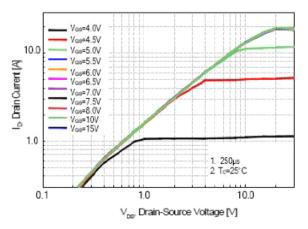


Fig.1 On-State Characteristics

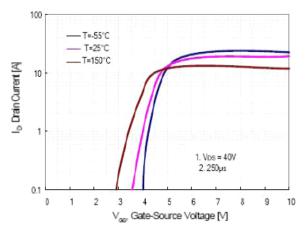


Fig.2 Transfer Current Characteristics

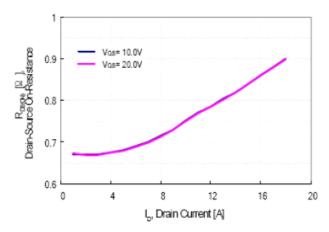


Fig.3 On-Resistance variation vs Drain Current

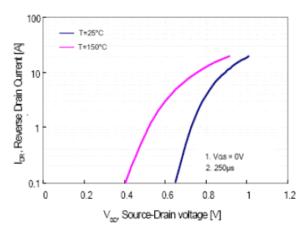


Fig.4 Body Diode Forward Voltage Variation with Source Current and Temperature

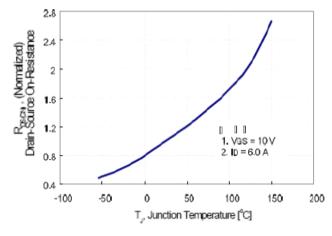


Fig.8 On-Resistance Variation vs Junction Temperature

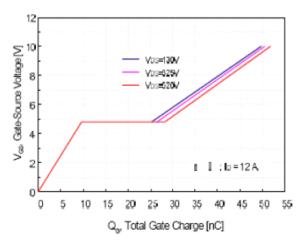
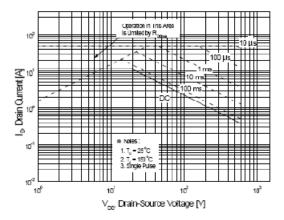


Fig.6 Gate Charge Characteristics





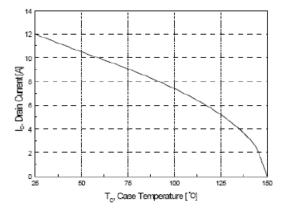


Fig.7 Maximum Safe Operation Area

Fig.8 Maximum Drain Current vs Case Temperature

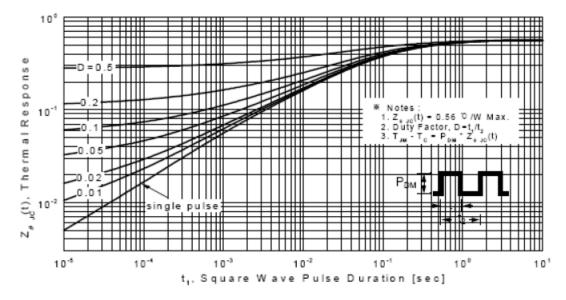


Fig.9 Transient Thermal Response curve



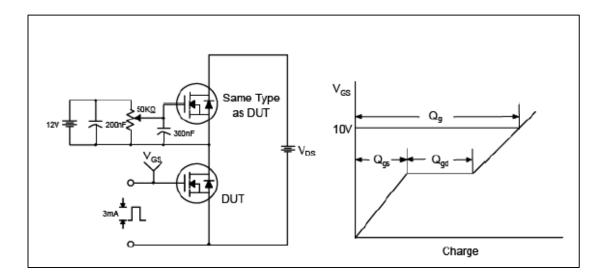


Fig.10 Gate Test circuit & Waveform

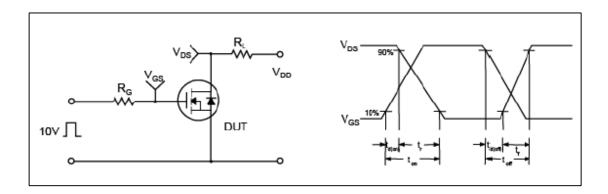


Fig.11 Resistive Switching Test Circuit & Waveform

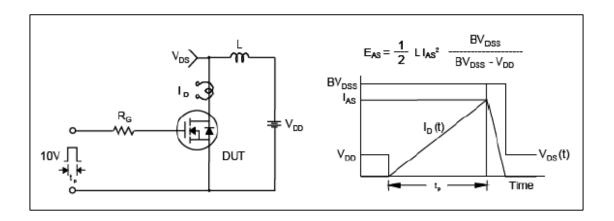


Fig.12 Uncamped Inductive Switching Test Circuit & Waveform

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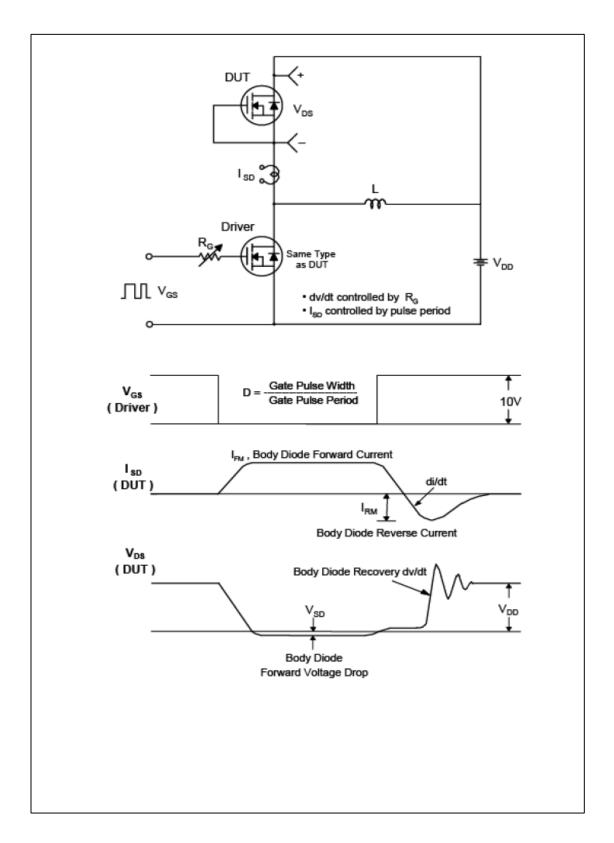


Fig.13 Peak Diode Recovery dv/dt Test Circuit & Waveform

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TO-220 Package Dimension

